TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HC10AP, TC74HC10AF

#### Triple 3-Input NAND Gate

The TC74HC10A is a high speed CMOS 3-INPUT NAND GATE fabricated with silicon gate  $C^2$ MOS technology.

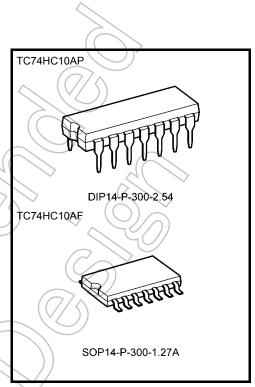
It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

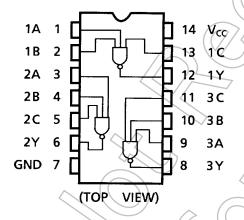
- High speed:  $t_{pd} = 6$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 1 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 4 mA (min)
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2 to 6 V
- Pin and function compatible with 74LS10



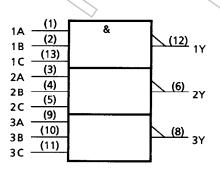
Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.)

## Pin Assignment



## **IEC Logic Symbol**



Start of commercial production 1986-05

#### **Truth Table**

Α	В	С	Υ
L	Х	Х	Н
Х	L	Х	Н
Х	Х	L	Н
Н	Н	Н	L

X: Don't care

## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7	V
DC input voltage	V <sub>IN</sub>	–0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	l <sub>IK</sub>	+20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	_mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	∫ mW
Storage temperature	T <sub>stg</sub>	-65 to 150	∕ °C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to  $65^{\circ}$ C. From Ta = 65 to  $85^{\circ}$ C a derating factor of -10 mW/°C shall be applied until 300 mW.

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2 to 6	V
Input voltage	VIN	0 to V <sub>CC</sub>	V
Output voltage	Vout	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 ( $V_{CC} = 6.0 \text{ V}$ )	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

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#### **Electrical Characteristics**

## **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta –40 to	Unit	
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
		_		2.0	1.50	_	1-	1.50	_	
High-level input voltage	$V_{IH}$			4.5	3.15	_	(F)	3.15	_	V
				6.0	4.20	_		4.20		
				2.0	_ <	+0	0.50	_	0.50	
Low-level input voltage	Low-level input		_			///	1.35	_	1.35	٧
				6.0	-(		1.80	_	1.80	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	_	
	V <sub>OH</sub>		$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0		5.9	<b>&gt;</b>	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	-6	4.13	> —	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	1	5.63	) —	
				2.0	_	0.0	0.1		0.1	
			I <sub>OL</sub> = 20 μA	4.5	_	0.0	0.1	>_	0.1	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		6.0	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I <sub>OL</sub> = 5.2 mA	6.0		0.18	0.26	_	0.33	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or	GND	6.0	_	<u></u>	±0.1		±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or	GND	6.0		/	1.0	_	10.0	μА

## AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $Ta = 25 ^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>	<u> </u>	_	4	8	ns
Propagation delay time	t <sub>pLH</sub>			6	12	ns

## AC Characteristics ( $C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta –40 to	Unit	
	-		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
	t		2.0	_	25	75	_	95	
Output transition time	t <sub>TLH</sub>	_	4.5	_	7 <	15	_	19	ns
	t <sub>THL</sub>		6.0	_	6	13	_	16	
	4		2.0	_	27	75	4	95	
Propagation delay time	<sup>t</sup> pLH	_	4.5	_	9	15	<i>9</i> _	19	ns
	t <sub>pHL</sub>		6.0	1	8(/	13	_	16	
Input capacitance	C <sub>IN</sub>	_		_	5			10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)			_((	23	· _	- (	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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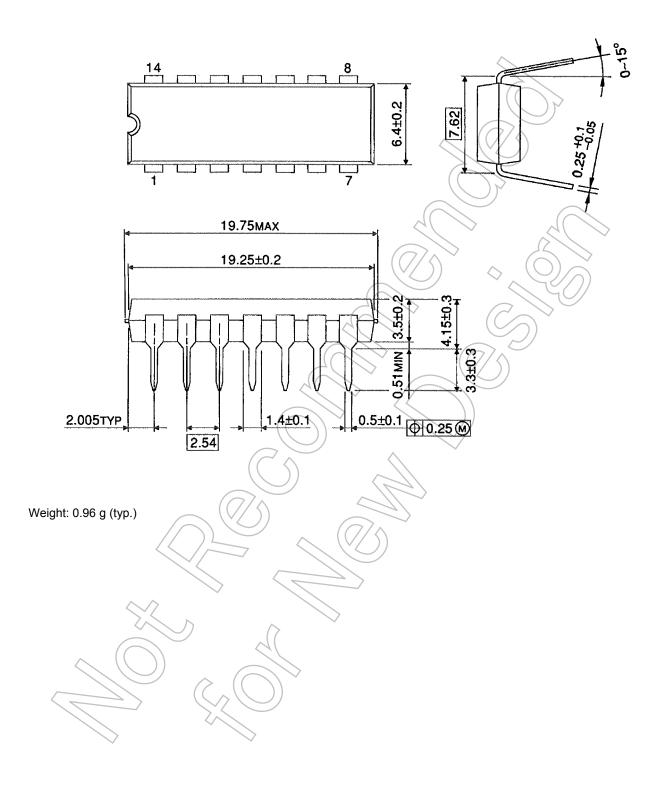
Average operating current can be obtained by the equation:

 $I_{CC}$  (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per gate)



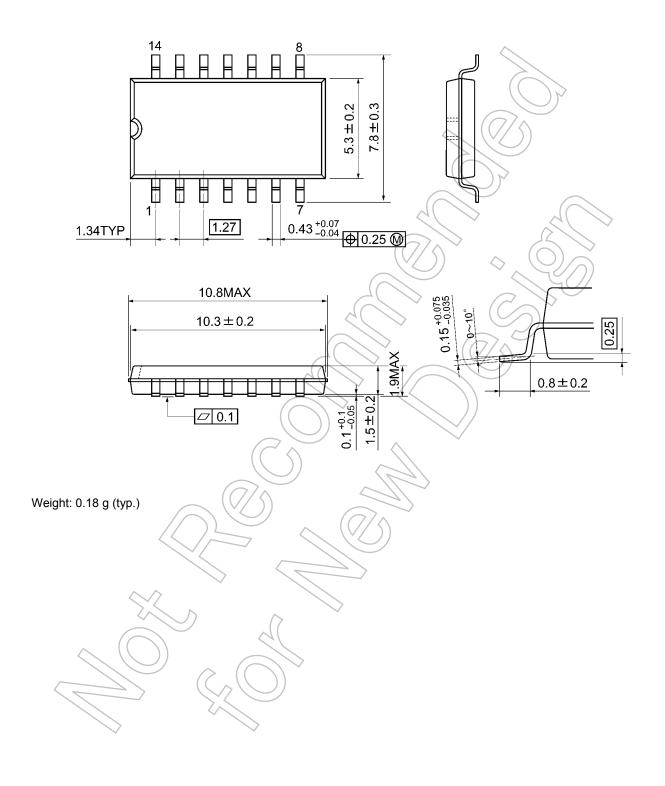
## **Package Dimensions**

DIP14-P-300-2.54 Unit: mm



## **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



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